503020500 10/16/2014

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 EPAS ID: PAT3067101 Stylesheet Version v1.2

 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
WEN-HSIUNG LIAO	06/02/2014
ROGER HSIEH	06/02/2014
HIDEO IKUTA	06/02/2014
YUEH-LANG CHEN	06/02/2014

RECEIVING PARTY DATA

Name:	CYNTEC CO., LTD.
Street Address:	NO.2, Research & Development 2nd RD., SCIENCE PARK
City:	Hsinchu
State/Country:	TAIWAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14294164

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email: janiceshih@litron-intl.com

Correspondent Name: MIN-LEE TENG

Address Line 1: 7F-2, NO. 79, SEC.2, ROOSEVELT RD.

Address Line 4: TAIPEI, TAIWAN

ATTORNEY DOCKET NUMBER: 6101.059US

NAME OF SUBMITTER: MIN-LEE TENG

SIGNATURE: /MIN-LEE TENG/

DATE SIGNED: 10/16/2014

Total Attachments: 2

source=RD-097-P2_6101.059US_ASSIGNMENT#page1.tif source=RD-097-P2_6101.059US_ASSIGNMENT#page2.tif

PATENT 503020500 REEL: 033958 FRAME: 0155

ASSIGNMENT (PATENT APPLICATION)

WHEREAS, we, ("ASSIGNORS"):

<u>Inventor</u>	<u>Citizenship</u>	<u>Address</u>
Liao, Wen-Hsiung	Taiwan, R. O. C.	No.5, Aly. 1, Sianjheng 21St., Jhubei City, Hsinchu City, Taiwan (R.O.C.)
Hsieh, Roger	Taiwan, R. O. C.	No.37-4, Shengli 5 th Rd., Jhubei City., Hsinchu City, Taiwan (R.O.C.)
Ikuta, Hideo	Taiwan, R. O. C.	c/o No.2, Research & Development 2 nd Rd., Science Park, Hsinchu City, Taiwan (R.O.C.)
Chen, Yueh-Lang	Taiwan, R. O. C	No.45, Aly.2, Lin.578, Sec1, Guangfu Rd., Hsinchu City, Taiwan(R. O. C.)

having invented a certain new and useful invention entitled:

ELECTRONIC DEVICE AND MANUFACTURING METHOD THEREOF

for which a United States patent app	lication is to be	filed or has been f	iled on <u>JUNE 3, 2014</u>	
under U.S. Patent Application No	14/294,164	; and		

WHEREAS, ("ASSIGNEE"):

CYNTEC CO., LTD NO. 2, RESEARCH & DEVELOPMENT 2ND RD. SCIENCE PARK, HSINCHU TAIWAN, R.O.C.

is desirous of acquiring the entire right, title and interest in and to the invention throughout the United States and the world, and all right, title and interest in, to and under any and all Letters Patent of the United States and all countries throughout the world;

FOR GOOD and VALUABLE CONSIDERATION, the full receipt and sufficiency of which are hereby acknowledged, ASSIGNORS, intending to be legally bound, do hereby:

AUTHORIZE said ASSIGNEE, or its representatives to insert above the filing date and application number of the application when these are known;

SELL, ASSIGN, TRANSFER and CONVEY to ASSIGNEE the whole and entire right, title and interest for the United States and its possessions and territories and all foreign countries in and to the invention which is disclosed in the above-identified patent application, and, in and to any and all patent applications related thereto including, but not limited to, all provisionals, non-provisionals, divisionals, continuations, continuations-in-part, substitutes, reexaminations, reissues and all other applications for patent which have been or shall be filed in the United States and all foreign countries on the invention; all original, reissued and reexamined patents and extensions thereof which have been or shall be issued in the United States and all foreign countries on the invention to the full end of the term or terms for which the patent(s) may be granted, as fully and entirely as the same would have been held by the undersigned

PATENT REEL: 033958 FRAME: 0156

RECORDED: 10/16/2014

ASSIGNOR(S) had this Assignment not been made; and specifically including all rights of priority created by the above patent application under any treaty, convention or law relating thereto;

AUTHORIZE and REQUEST the issuing authority to issue any and all United States and foreign patents granted on the invention to ASSIGNEE;

WARRANT and REPRESENT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by ASSIGNORS, and that the full right to convey the same as herein expressed is possessed by ASSIGNORS;

AGREE and UNDERTAKE, when requested and at the expense of ASSIGNEE, to carry out in good faith the intent and purpose of this Assignment, ASSIGNORS will execute all non-provisionals, divisionals, continuations, continuations-in-part, substitutes, reexaminations, reissues, and all other patent applications on the invention; execute all lawful oaths, declarations, assignments, powers of attorney and other papers; communicate to ASSIGNEE all facts known to ASSIGNORS relating to the invention and the history thereof; and generally do everything possible which ASSIGNEE shall consider desirable for vesting title to the invention in ASSIGNEE, and for securing, maintaining and enforcing proper patent protection for the invention; all without further compensation to ASSIGNORS;

AGREES to hold in trust, keep confidential, not make use of, and not disclose or reveal to any third party said invention, without ASSIGNEE'S prior written consent.

TO BE BINDING on the heirs, assigns, representatives and successors of ASSIGNORS and extending to the successors, assigns, and nominees of ASSIGNEE.

06/02/2014	/ Liao, Wen-Hsiung /		
Date	Liao, Wen-Hsiung		
06/02/2014	/ Hsieh, Roger /		
Date	Hsieh, Roger		
06/02/2014	/ Ikuta, Hideo /		
Date	Ikuta, Hideo		
06/02/2014	/ Chen, Yueh-Lang /		
Date	Chen, Yueh-Lang		

PATENT REEL: 033958 FRAME: 0157